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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Active
Core Processor	eZ8
Core Size	8-Bit
Speed	20MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, LED, POR, PWM, WDT
Number of I/O	23
Program Memory Size	12KB (12K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8f1232sj020eg

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

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Block Diagram

Figure 1 displays a block diagram of the Z8 Encore! F0830 Series architecture.

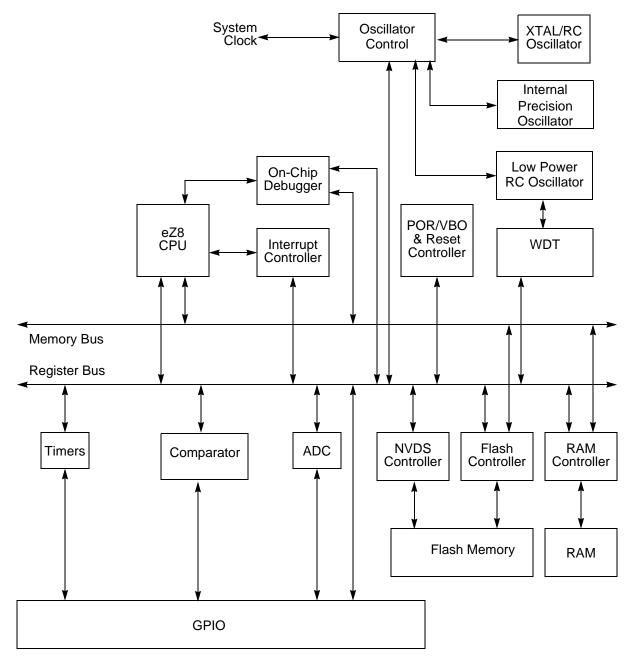


Figure 1. Z8 Encore! F0830 Series Block Diagram

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Bit	7	6	5	4	3	2	1	0
Field	POR	STOP	WDT	EXT		Rese	erved	·
RESET	:	See Table 13	3	0	0	0	0	0
R/W	R	R	R	R	R	R	R	R
Address				FF	ОH			
Bit	Descriptio	Description						
[7] POR	Power-On Reset Indicator This bit is set to 1 if a Power-On Reset event occurs and is reset to 0, if a WDT time-out or Stop Mode Recovery occurs. Reading this register also reset this bit to 0.							
[6] STOP	Stop Mode Recovery Indicator This bit is set to 1 if a Stop Mode Recovery occurs. If the STOP and WDT bits are both set to 1, the Stop Mode Recovery occurs because of a WDT time-out. If the STOP bit is 1 and the WDT bit is 0, the Stop Mode Recovery is not caused by a WDT time-out. This bit is reset by a Power-On Reset or a WDT time-out that occurred while not in STOP Mode. Reading this register also resets this bit.					nd the WDT by a Power-		
[5] WDT	Watchdog Timer Time-Out Indicator This bit is set to 1 if a WDT time-out occurs. A Power-On Reset resets this pin. A Stop Mode Recovery from a change in an input pin also resets this bit. Reading this register resets this bit. This read must occur before clearing the WDT interrupt.					•		
[4] EXT	External Reset Indicator If this bit is set to 1, a reset initiated by the external RESET pin occurred. A Power-On Reset or a Stop Mode Recovery from a change in an input pin resets this bit. Reading this register resets this bit.							
[3:0]	Reserved These registers are reserved and must be programmed to 0000.							

Table 13. POR Indicator Values

Reset or Stop Mode Recovery Event	POR	STOP	WDT	EXT
Power-On Reset	1	0	0	0
Reset using RESET pin assertion	0	0	0	1
Reset using Watchdog Timer time-out	0	0	1	0
Reset using the On-Chip Debugger (OCTCTL[1] set to 1)	1	0	0	0
Reset from STOP Mode using DBG pin driven Low	1	0	0	0
Stop Mode Recovery using GPIO pin transition	0	1	0	0
Stop Mode Recovery using WDT time-out	0	1	1	0

• Writing 1 to the IRQE bit in the Interrupt Control Register

Interrupts are globally disabled by any of the following actions:

- Execution of a DI (disable interrupt) instruction
- eZ8 CPU acknowledgement of an interrupt service request from the Interrupt Controller
- Writing a 0 to the IRQE bit in the Interrupt Control Register
- Reset
- Execution of a trap instruction
- Illegal instruction Trap
- Primary oscillator fail trap
- Watchdog Oscillator fail trap

Interrupt Vectors and Priority

The Interrupt Controller supports three levels of interrupt priority. Level 3 is the highest priority, level 2 is the second highest priority and level 1 is the lowest priority. If all of the interrupts are enabled with identical interrupt priority (all as level 2 interrupts, for example), the interrupt priority is assigned from highest to lowest as specified in <u>Table 34</u> on page 54. Level 3 interrupts are always assigned higher priority than level 2 interrupts and level 2 interrupts are assigned higher priority than level 1 interrupts. Within each interrupt priority level (level 1, level 2 or level 3), priority is assigned as specified in Table 34, above. Reset, Watchdog Timer interrupt (if enabled), primary oscillator fail trap, Watchdog Oscillator fail trap and illegal instruction trap always have highest (level 3) priority.

Interrupt Assertion

Interrupt sources assert their interrupt requests for only a single system clock period (single pulse). When the interrupt request is acknowledged by the eZ8 CPU, the corresponding bit in the interrupt request register is cleared. Writing 0 to the corresponding bit in the interrupt request register clears the interrupt request.

Caution: Zilog recommends not using a coding style that clears bits in the Interrupt Request registers. All incoming interrupts received between execution of the first LDX command and the final LDX command are lost. See Example 1, which follows.

Example 1. A poor coding style that can result in lost interrupt requests:

Timers

The Z8 Encore! F0830 Series products contain up to two 16-bit reloadable timers that can be used for timing, event counting or generation of pulse width modulated (PWM) signals. The timers feature include:

- 16-bit reload counter
- Programmable prescaler with prescale values ranging from 1 to 128
- PWM output generation
- Capture and compare capability
- External input pin for timer input, clock gating or capture signal. External input pin signal frequency is limited to a maximum of one-fourth the system clock frequency
- Timer output pin
- Timer interrupt

Architecture

Figure 10 displays the architecture of the timers.

 $PWM Period (s) = \frac{Reload Value \times Prescale}{System Clock Frequency (Hz)}$

If an initial starting value other than 0001H is loaded into the Timer High and Low Byte registers, use the ONE-SHOT Mode equation to determine the first PWM time-out period.

If TPOL bit is set to 0, the ratio of the PWM output high time to the total period is represented by:

PWM Output High Time Ratio (%) = $\frac{\text{Reload Value} - \text{PWM Value}}{\text{Reload Value}} \times 100$

If TPOL bit is set to 1, the ratio of the PWM output high time to the total period is represented by:

PWM Output High Time Ratio (%) = $\frac{\text{PWM Value}}{\text{Reload Value}} \times 100$

PWM DUAL OUTPUT Mode

In PWM DUAL OUTPUT Mode, the timer outputs a PWM output signal pair (basic PWM signal and its complement) through two GPIO port pins. The timer input is the system clock. The timer first counts up to 16-bit PWM match value stored in the timer PWM High and Low Byte registers. When the timer count value matches the PWM value, the timer output toggles. The timer continues counting until it reaches the reload value stored in the Timer Reload High and Low Byte registers. Upon reaching the reload value, the timer generates an interrupt, the count value in the Timer High and Low Byte registers is reset to 0001H and counting resumes.

If the TPOL bit in the Timer Control Register is set to 1, the timer output signal begins as a High (1) and transitions to a Low (0) when the timer value matches the PWM value. The timer output signal returns to a High (1) after the timer reaches the reload value and is reset to 0001H.

If the TPOL bit in the Timer Control Register is set to 0, the timer output signal begins as a Low (0) and transitions to a High (1) when the timer value matches the PWM value. The timer output signal returns to a Low (0) after the timer reaches the reload value and is reset to 0001H.

The timer also generates a second PWM output signal: the timer output complement. The timer output complement is the complement of the timer output PWM signal. A programmable deadband delay can be configured to time delay (0 to 128 system clock cycles) PWM output transitions on these two pins from a Low to a High (inactive to active) to ensure a time gap between the deassertion of one PWM output to the assertion of its complement.

PWM Output High Time Ratio (%) = $\frac{\text{Reload Value} - \text{PWM Value}}{\text{Reload Value}} \times 100$

If TPOL is set to 1, the ratio of the PWM output high time to the total period is represented by:

PWM Output High Time Ratio (%) =
$$\frac{PWM \text{ Value}}{\text{Reload Value}} \times 100$$

CAPTURE Mode

In CAPTURE Mode, the current timer count value is recorded when the appropriate external timer input transition occurs. The capture count value is written to the timer PWM High and Low Byte registers. The timer input is the system clock. The TPOL bit in the Timer Control Register determines if the capture occurs on a rising edge or a falling edge of the timer input signal.

When the capture event occurs, an interrupt is generated and the timer continues counting. The INPCAP bit in the TxCTL1 Register is set to indicate the timer interrupt because of an input capture event.

The timer continues counting up to the 16-bit reload value stored in the Timer Reload High and Low Byte registers. Upon reaching the reload value, the timer generates an interrupt and continues counting. The INPCAP bit in the TxCTL1 Register clears, indicating that the timer interrupt has not occurred because of an input capture event.

Observe the following steps for configuring a timer for CAPTURE Mode and initiating the count:

- 1. Write to the Timer Control Register to:
 - Disable the timer
 - Configure the timer for CAPTURE Mode
 - Set the prescale value
 - Set the capture edge (rising or falling) for the timer input
- 2. Write to the Timer High and Low Byte registers to set the starting count value (typically 0001H).
- 3. Write to the Timer Reload High and Low Byte registers to set the reload value.
- 4. Clear the timer PWM High and Low Byte registers to 0000H. Clearing these registers allows user software to determine if interrupts were generated either by a capture event or by a reload. If the PWM High and Low Byte registers still contain 0000H after the interrupt, the interrupt were generated by a reload.

WDT Reset in Normal Operation

If configured to generate a reset when a time-out occurs, the Watchdog Timer forces the device into the System Reset state. The WDT status bit in the Watchdog Timer Control Register is set to 1. See *the* <u>Reset and Stop Mode Recovery</u> *chapter on page 21* for more information about system reset operations.

WDT Reset in STOP Mode

If configured to generate a reset when a time-out occurs and the device is in STOP Mode, the Watchdog Timer initiates a Stop Mode Recovery. Both the WDT status bit and the STOP bit in the Watchdog Timer Control Register are set to 1 following WDT time-out in STOP Mode. See *the* <u>Reset and Stop Mode Recovery</u> *chapter on page 21* for more information about Stop Mode Recovery operations.

Watchdog Timer Reload Unlock Sequence

Writing the unlock sequence to the Watchdog Timer (WDTCTL) Control Register address, unlocks the three Watchdog Timer Reload Byte registers (WDTU, WDTH and WDTL) to allow changes to the time-out period. These write operations to the WDTCTL Register address produce no effect on the bits in the WDTCTL Register. The locking mechanism prevents spurious writes to the reload registers.

The following sequence is required to unlock the Watchdog Timer Reload Byte registers (WDTU, WDTH and WDTL) for write access:

- 1. Write 55H to the Watchdog Timer Control Register (WDTCTL).
- 2. Write AAH to the Watchdog Timer Control Register (WDTCTL).
- 3. Write the Watchdog Timer Reload Upper Byte Register (WDTU).
- 4. Write the Watchdog Timer Reload High Byte Register (WDTH).
- 5. Write the Watchdog Timer Reload Low Byte Register (WDTL).

All three Watchdog Timer Reload registers must be written in the order listed above. There must be no other register writes between each of these operations. If a register write occurs, the lock state machine resets and no further writes can occur unless the sequence is restarted. The value in the Watchdog Timer Reload registers is loaded into the counter when the Watchdog Timer is first enabled and every time a WDT instruction is executed.

Table 62. Watchdog Timer Reload Low Byte Register (WDTL)

Bit	7	6	5	4	3	2	1	0
Field				W	DTL			
RESET	0	0	0	0	0	0	0	0
R/W	R/W*	R/W*	R/W*	R/W*	R/W*	R/W*	R/W*	R/W*
Address				FF	3H			
Note: *A r	ead returns th	he current WI	DT count valu	e; a write set	s the appropr	iate reload va	llue.	
Bit	Descriptio	n						

DR	Description
[7:0]	WDT Reload Low
WDTL	Least significant byte (LSB), bits[7:0] of the 24-bit WDT reload value.

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1FFFH		 Page 15	1FFFH 1E00H
	Sector 7	Page 14	1DFFH 1C00H
1C00H 18FFH		 Page 13	1BFFH 1A00H
	Sector 6	 Page 12	19FFH 1800H
1800H 17FFH		 Page 11	17FFH 1600H
1400H	Sector 5	 Page 10	15FFH 1400H
13FFH		 Page 9	13FFH 1200H
	Sector 4	 Page 8	11FFH
1C00H 0FFFH	Sector 3	 Page 7	1C00H 0FFFH
0C00H	Seciol 3	Page 6	0E00H 0DFFH
0BFFH	On star 0	 Page 5	0C00H 0BFFH
0800H	Sector 2	 Page 4	0A00H 09FFH
07FFH	Sector 1	Page 3	0800H 07FFH
0400H	Sector 1	 Page 2	0600H 05FFH
03FFH	Sector 0	Page 1	0400H 03FFH
0000H		 Page 0	0200H 0100H
			0000H

Figure 17. 8K Flash with NVDS

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Flash Option Bits

Programmable Flash option bits allow user configuration of certain aspects of Z8 Encore! F0830 Series operation. The feature configuration data is stored in the Flash program memory and read during reset. The features available for control through the Flash option bits are:

- Watchdog Timer time-out response selection-interrupt or system reset
- Watchdog Timer enabled at reset
- The ability to prevent unwanted read access to user code in program memory
- The ability to prevent accidental programming and erasure of all or a portion of the user code in program memory
- Voltage Brown-Out configuration always enabled or disabled during STOP Mode to reduce STOP Mode power consumption
- OSCILLATOR Mode selection for high, medium and low power crystal oscillators or external RC oscillator
- Factory trimming information for the Internal Precision Oscillator and VBO voltage

Operation

This section describes the type and configuration of the programmable Flash option bits.

Option Bit Configuration by Reset

Each time the Flash option bits are programmed or erased, the device must be reset for the change to be effective. During any Reset operation (system reset or Stop Mode Recovery), the Flash option bits are automatically read from Flash program memory and written to the Option Configuration registers, which control Z8 Encore! F0830 Series device operation. Option bit control is established before the device exits reset and the eZ8 CPU begins code execution. The Option Configuration registers are not part of the register file and are not accessible for read or write access.

Note: The bit values used in Table 85 are set at the factory; no calibration is required.

Table 86. Trim Option Bits at 0002H (TIPO)

Bit	7	6	5	4	3	2	1	0
Field		IPO_TRIM						
RESET		U						
R/W		R/W						
Address		Information Page Memory 0022H						
Note: U =	Unchanged b	by Reset. R/W	/ = Read/Writ	e.				

Bit	Description
[7:0]	Internal Precision Oscillator Trim Byte
IPO_TRIM	Contains trimming bits for the Internal Precision Oscillator.

Note: The bit values used in Table 86 are set at the factory; no calibration is required.

Table 87. Trim Option Bits at 0003H (TVBO)

Bit	7	6	5	4	3	2	1	0
Field	Reserved				Reserved	VBO_TRIM		
RESET		U				1	0	0
R/W		R/W					R/W	
Address		Information Page Memory 0023H						
Note: U =	te: U = Unchanged by Reset. R/W = Read/Write.							

Bit	Description
[7:3]	Reserved These bits are reserved and must be programmed to 11111.
[2]	VBO Trim Values
VBO_TRIM	Contains factory-trimmed values for the oscillator and the VBO.

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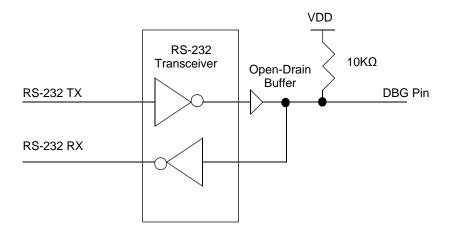


Figure 22. Interfacing the On-Chip Debugger's DBG Pin with an RS-232 Interface, #2 of 2

DEBUG Mode

The operating characteristics of the devices in DEBUG Mode are:

- The eZ8 CPU fetch unit stops, idling the eZ8 CPU, unless directed by the OCD to execute specific instructions
- The system clock operates, unless the device is in STOP Mode
- All enabled on-chip peripherals operate, unless the device is in STOP Mode
- Automatically exits HALT Mode
- Constantly refreshes the Watchdog Timer, if enabled

Entering DEBUG Mode

- The device enters DEBUG Mode after the eZ8 CPU executes a Breakpoint (BRK) instruction
- If the DBG pin is held low during the most recent clock cycle of system reset, the device enters DEBUG Mode on exiting system reset

Exiting DEBUG Mode

The device exits DEBUG Mode following any of these operations:

- Clearing the DBGMODE bit in the OCD Control Register to 0
- Power-On Reset
- Voltage Brown-Out reset

When selecting a new clock source, the primary oscillator failure detection circuitry and the Watchdog Timer Oscillator failure circuitry must be disabled. If POFEN and WOFEN are not disabled prior to a clock switch-over, it is possible to generate an interrupt for a failure of either oscillator. The failure detection circuitry can be enabled anytime after a successful write of OSCSEL in the Oscillator Control Register.

The Internal Precision Oscillator is enabled by default. If the user code changes to a different oscillator, it may be appropriate to disable the IPO for power savings. Disabling the IPO does not occur automatically.

Clock Failure Detection and Recovery

Primary Oscillator Failure

The Z8F04xA family devices can generate nonmaskable interrupt-like events when the primary oscillator fails. To maintain system function in this situation, the clock failure recovery circuitry automatically forces the Watchdog Timer Oscillator to drive the system clock. The Watchdog Timer Oscillator must be enabled to allow the recovery. Although this oscillator runs at a much slower speed than the original system clock, the CPU continues to operate, allowing execution of a clock failure vector and software routines that either remedy the oscillator failure or issue a failure alert. This automatic switch-over is not available if the Watchdog Timer is the primary oscillator. It is also unavailable if the Watchdog Timer reset function outlined in the Watchdog Timer chapter of this document.

The primary oscillator failure detection circuitry asserts if the system clock frequency drops below 1 KHz \pm 50%. If an external signal is selected as the system oscillator, it is possible that a very slow but nonfailing clock can generate a failure condition. Under these conditions, do not enable the clock failure circuitry (POFEN must be deasserted in the OSCCTL Register).

Watchdog Timer Failure

In the event of failure of a Watchdog Timer Oscillator, a similar nonmaskable interruptlike event is issued. This event does not trigger an attendant clock switch-over, but alerts the CPU of the failure. After a Watchdog Timer failure, it is no longer possible to detect a primary oscillator failure. The failure detection circuitry does not function if the Watchdog Timer is used as the primary oscillator or if the Watchdog Timer Oscillator has been disabled. For either of these cases, it is necessary to disable the detection circuitry by deasserting the WDFEN bit of the OSCCTL Register.

The Watchdog Timer Oscillator failure detection circuit counts system clocks while looking for a Watchdog Timer clock. The logic counts 8004 system clock cycles before determining that a failure has occurred. The system clock rate determines the speed at which the Watchdog Timer failure is detected. A very slow system clock results in very slow detection times.

Assembly		Address Mode		Op Code(s)	Flags						Fetch	Instr.
Mnemonic	Symbolic Operation	dst	src	(Hex)	С	Ζ	S	۷	D	Н		
AND dst, src	$dst \gets dst \; AND \; src$	r	r	52	_	*	*	0	_	_	2	3
		r	lr	53	_						2	4
		R	R	54							3	3
		R	IR	55	_						3	4
		R	IM	56	_						3	3
		IR	IM	57	_						3	4
ANDX dst, src	$dst \gets dst \ AND \ src$	ER	ER	58	_	*	*	0	_	_	4	3
		ER	IM	59	_						4	3
ATM	Block all interrupt and DMA requests during execution of the next 3 instructions			2F	-	_	_	_	_	_	1	2
BCLR bit, dst	dst[bit] ← 0	r		E2	_	*	*	0	_	_	2	2
BIT p, bit, dst	dst[bit] ← p	r		E2	_	*	*	0	_	_	2	2
BRK	Debugger Break			00	-	_	-	-	_	_	1	1
BSET bit, dst	dst[bit] ← 1	r		E2	-	*	*	0	-	-	2	2
BSWAP dst	dst[7:0] ← dst[0:7]	R		D5	Х	*	*	0	-	-	2	2
BTJ p, bit, src,	if src[bit] = p		r	F6	-	_	-	-	_	_	3	3
dst	$PC \leftarrow PC + X$		lr	F7	_						3	4
BTJNZ bit, src,			r	F6	-	-	-	-	-	-	3	3
dst	$PC \leftarrow PC + X$		lr	F7	_						3	4
BTJZ bit, src,	if src[bit] = 0		r	F6	-	_	-	-	_	-	3	3
dst	$PC \gets PC + X$		Ir	F7							3	4
CALL dst	$SP \leftarrow SP - 2$	IRR		D4	_	_	_	_	_	_	2	6
	@SP ← PC PC ← dst	DA		D6							3	3
CCF	$C \leftarrow \sim C$			EF	*	_	_	_	_		1	2

Table 113. eZ8 CPU Instruction Summary (Continued)

Note: Flags Notation:

* = Value is a function of the result of the operation.

- = Unaffected.

X = Undefined.

0 = Reset to 0.

1 = Set to 1.

DC Characteristics

Table 116 lists the DC characteristics of the Z8 Encore! F0830 Series products. All voltages are referenced to V_{SS} , the primary system ground.

	T _A = 0°C to +70°C			T _A = -40°C to +105°C					
Parameter	Min	Тур	Max	Min	Тур	Max	Units	Conditions	
Supply Voltage				2.7	_	3.6	V	Power supply noise not to exceed 100mV peak to peak	
Low Level Input Voltage				-0.3	_	0.3*V _D D	V	For all input pins except RESET.	
Low Level Input Voltage				-0.3	_	0.8	V	For RESET.	
High Level Input Voltage				2.0	_	5.5	V	For all input pins without analog or oscillator func- tion.	
High Level Input Voltage				2.0	_	V _{DD} +0. 3	V	For those pins with ana- log or oscillator function.	
Low Level Output Voltage				-	-	0.4	V	$I_{OL} = 2mA; V_{DD} = 3.0V$ High Output Drive disabled.	
High Level Output Voltage				2.4	_	-	V	$I_{OH} = -2mA; V_{DD} = 3.0V$ High Output Drive dis- abled.	
Low Level Output Voltage				-	_	0.6	V	$I_{OL} = 20$ mA; $V_{DD} = 3.3$ V High Output Drive enabled.	
High Level Output Voltage				2.4	_	-	V	$I_{OH} = -20 \text{ mA};$ $V_{DD} = 3.3 \text{ V}$ High Output Drive enabled.	
Input Leakage Current				-5	_	+5	μΑ	$V_{DD} = 3.6 \text{V};$ $V_{IN} = V_{DD} \text{ or } V_{SS}^{1}$	
Tristate Leakage Current				-5	_	+5	μA	V _{DD} = 3.6 V	
	Supply Voltage Low Level Input Voltage Low Level Input Voltage High Level Input Voltage Low Level Output Voltage Low Level Output Voltage High Level Output Voltage High Level Output Voltage Input Leakage Current	ParameterMinSupply VoltageImSupply VoltageImLow Level Input VoltageImLow Level Input VoltageImHigh Level Input VoltageImHigh Level Input VoltageImLow Level Output VoltageImHigh Level Input VoltageImSupply VoltageImInput Leakage CurrentImput Leakage	ParameterMinTypSupply VoltageImage: Constant of the second of the s	ParameterMinTypMaxSupply VoltageImage: Supply VoltageImage: Supply VoltageImage: Supply VoltageLow Level Input VoltageImage: Supply VoltageImage: Supply VoltageImage: Supply VoltageHigh Level Input VoltageImage: Supply VoltageImage: Supply VoltageImage: Supply VoltageHigh Level Input VoltageImage: Supply VoltageImage: Supply VoltageImage: Supply VoltageLow Level Output VoltageImage: Supply VoltageImage: Supply VoltageImage: Supply VoltageHigh Level Output VoltageImage: Supply VoltageImage: Supply VoltageImage: Supply VoltageHigh Level Output VoltageImage: Supply VoltageImage: Supply VoltageImage: Supply VoltageInput Leakage CurrentImage: Supply VoltageImage: Supply VoltageImage: Supply VoltageInput Leakage CurrentImage: Supply VoltageImage: Supply VoltageImage: Supply Voltage	NumNumNumParameterMinTypMaxMinSupply Voltage2.72.7Low Level Input Voltage-0.3-0.3Low Level Input Voltage-0.3-0.3High Level Input Voltage2.02.0High Level Input Voltage2.0-0.3High Level Input Voltage2.0-0.3Low Level Output Voltage-2.0Low Level Output VoltageHigh Level Output VoltageHigh Level Output VoltageLow Level Output VoltageInput Leakage Current-5-5Tristate Leakage-5-5	ParameterMinTypMaxMinTypSupply Voltage2.7-Low Level Input Voltage-0.3-Low Level Input Voltage-0.3-High Level Input Voltage2.0-High Level Input Voltage2.0-High Level Input Voltage2.0-Low Level Output VoltageHigh Level Input Voltage2.0-High Level Output VoltageHigh Level Output VoltageLow Level Output VoltageHigh Level Output VoltageInput Leakage Current-5-Tristate Leakage-5-	ParameterMinTypMaxMinTypMaxSupply Voltage 2.7 $ 3.6$ Low Level Input Voltage -0.3 D $ 0.3^*V_D$ DLow Level Input Voltage -0.3 D $ 0.3^*V_D$ DHigh Level Input Voltage -0.3 D $ 0.3^*V_D$ DHigh Level Input 	ParameterMinTypMaxMinTypMaxUnitsSupply Voltage 2.7 $ 3.6$ VLow Level Input Voltage -0.3 $ 0.3^*V_D$ DV DLow Level Input Voltage -0.3 $ 0.3^*V_D$ DV DLow Level Input Voltage -0.3 $ 0.3^*V_D$ DV DHigh Level Input Voltage 2.0 $ 5.5$ SVHigh Level Input Voltage 2.0 $ V_{DD}+0.$ SV SHigh Level Input Voltage 2.0 $ 0.4$ SVLow Level Output Voltage $ 0.4$ VHigh Level Output Voltage 2.4 $ -$ VHigh Level Output Voltage 2.4 $ V$ High Level Output Voltage 2.4 $ V$ High Level Output Voltage -5 $ +5$ μ A	

Table 116. DC Characteristics	Table	ics
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Notes:

1. This condition excludes all pins that have on-chip pull-ups, when driven Low.

2. These values are provided for design guidance only and are not tested in production.

3. See Figure 31 for HALT Mode current.

Packaging

Zilog's F0830 Series of MCUs includes the Z8F0130, Z8F0131, Z8F0230, Z8F0231, Z8F1232 and Z8F1233 devices, which are available in the following packages:

- 20-Pin Quad Flat No-Lead Package (QFN)
- 20-pin Small Outline Integrated Circuit Package (SOIC)
- 20-pin Plastic Dual-Inline Package (PDIP)
- 20-pin Small Shrink Outline Package (SSOP)
- 28-Pin Quad Flat No-Lead Package (QFN)
- 28-pin Small Outline Integrated Circuit Package (SOIC)
- 28-pin Plastic Dual-Inline Package (PDIP)
- 28-pin Small Shrink Outline Package (SSOP)

Current diagrams for each of these packages are published in Zilog's <u>Packaging Product</u> <u>Specification (PS0072)</u>, which is available free for download from the Zilog website.

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Table 129 lists the pin count by package.

	Pin Count					
Package	20	28				
PDIP	\checkmark					
QFN	\checkmark					
SOIC	\checkmark					
SSOP	\checkmark					

Table 129. Package and Pin Count Description

Hex Address: FF8

Table 192. Flash Status Register (FSTAT)

Bit	7	6	5	4	3	2	1	0		
Field	Rese	erved			FSTAT					
RESET	0	0	0	0	0	0	0	0		
R/W	R	R	R	R	R	R	R	R		
Address		FF8H								

Hex Address: FF9

The Flash Page Select Register is shared with the Flash Sector Protect Register.

Table 193. Flash Page Select Register (FPS)

Bit	7	6	5	4	3	2	1	0		
Field	INFO_EN		PAGE							
RESET	0	0	0	0	0	0	0	0		
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W		
Address		FF9H								

Table 194. Flash Sector Protect Register (FPROT)

Bit	7	6	5	4	3	2	1	0			
Field	SPROT7	SPROT6	SPROT5	SPROT4	SPROT3	SPROT2	SPROT1	SPROT0			
RESET	0	0	0	0	0	0	0	0			
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W			
Address		FF9H									

Hex Address: FFA

Table 195. Flash Frequency High Byte Register (FFREQH)

Bit	7	6	5	4	3	2	1	0			
Field	FFREQH										
RESET	0	0	0	0	0	0	0	0			
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W			
Address		FFAH									

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